

## Organizing Committee

### Conference General Chair:

Xavier Fernando (Ryerson University)

### Technical Program Co-Chairs:

Vijay K. Sood (UOIT)

Robert Allison (York University)

### Publications Chair:

Marcelo Mota

(Greater Toronto Airport Authority)

### Government and Industry Relations Chair:

#### Conference Spokesperson:

Dimitri Androutsos (Ryerson University)

### Finance Chair:

Kash Husain (Dillon Consulting Ltd)

### Tutorials Chair:

Bruno Di-Stefano (Nuptek Systems Ltd)

### Registration Chair:

Behnaz Ghoraani (Ryerson University)

### Sponsorship Chair:

Benjamin Mak (Ridout & Maybee LLP)

### Publicity Chair:

Shahab Ardalan (Gennum Corp.)

### Global Outreach Chair:

Dan Hosseinzadeh (Sunnybrook Hospital)

### Local Arrangements and AV Chair:

Pelle Westlind (Pelle Westlind Consulting Services)

### Web Conferencing Chair:

Fasih Masood (BMO Financial Group)

### Member-at-Large:

Wai Tung Ng (University of Toronto)

### Webmaster:

Karl Martin (University of Toronto)

## Important Deadlines

Abstract Submission: March 6, 2009

Full Papers Submission: May 1, 2009

Notification of Acceptance: June 26, 2009

Camera Ready Copy: July 31, 2009

Author's Registration: July 31, 2009

Advance Registration: August 28, 2009

# 2009 IEEE Toronto International Conference Science and Technology for Humanity (TIC- STH 2009)

<http://www.TIC-STH2009.org>

September 26-27 2009, Toronto Marriott Downtown Eaton  
Centre, Toronto, Canada

## Symposium on Sensors and Applications

### Call for Papers

Papers are invited in the areas related, but are not limited, to the following topics:

- Biomedical Sensors
- Actuator Systems
- Electrochemical Sensors
- Physical Sensors
- Optical Sensors
- Electromagnetic Sensors
- Nanosensors

All submissions must conform to the TIC-STH 2009 submission policy and should be in English language.

### Symposium Technical Program Committee

Chair: **Dr Krishnan Venkatakrishnan** (Ryerson University)

Co-Chair: **Dr Bo Tan** (Ryerson University)

Member: **Dr M. Sivakumar** (Ryerson University)

### Special Features of the Conference

Prestigious International Conference

Full-Paper Peer Review and Publication in the IEEE Xplore™

Participate On-Site in Toronto or On-Line from Anywhere

Low Registration Fee of \$299 that Include Valuable Tutorials and Admission to More than 20  
Symposiums Focusing on Advanced Interdisciplinary Areas across a Broad Spectrum NOT limited to the  
traditional IEEE areas